PATENT ASSIGNMENT

Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Mr. Masahiko Namikawa	06/03/2004
Mr. Taro Kaneko	06/03/2004

RECEIVING PARTY DATA

Name:	NEC Corporation	
Street Address:	7-1, Shiba 5-chome, Minato-ku,	
City:	Tokyo	
State/Country:	JAPAN	

PROPERTY NUMBERS Total: 1

Property Type	Number	
Application Number:	10877786	

CORRESPONDENCE DATA

Fax Number: (212)940-8776

Correspondence will be sent via US Mail when the fax attempt is unsuccessful.

Phone: (212) 940-6731

Email: james.dade@kmzr.com

Correspondent Name: James J. Dade
Address Line 1: 575 Madison Avenue

Address Line 4: New York, NEW YORK 10022-8508

NAME OF SUBMITTER: Michael I. Markowitz

Total Attachments: 2

source=Takahashi Company#page1.tif source=Takahashi Company#page2.tif

CH \$40.00

PATENT REEL: 015063 FRAME: 0943

ASSIGNMENT

Docket No. NECS 21.251

SEMICONDUCTOR	LASER MODULE AND METHOD OF ASSEMBLING THE SAME
for which (check one)	[X] an application is being filed concurrently herewith,
	and given Application Serial No
and WHEREAS,	NEC Corporation ess at 7-1, Shiba 5-chome, Minato-ku, Tokyo, Japan
	, ASSIGNEE
is desirous of obtaining	the entire right, title and interest in, to and under the said invention and the said application.
and set over, and by the legal representatives and States application and a granted thereon and all a without limitation, all apin any country or countr claim for the same the p States, the International domestic laws of the couproperty protection, incl	the receipt of which is hereby acknowledged, the said ASSIGNOR has sold, assigned, transferred as presents does hereby sell, assign, transfer and set over, unto the said ASSIGNEE, its successor d assigns, the entire right, title and interest in, to and under the said invention, and the said United III divisions, renewals and continuations thereof, and all Patents of the United States which may be reissues and extensions thereof; and all applications for industrial property protection, including, applications for patents, utility models, and designs which may hereafter be filed for said invention ries foreign to the United States, together with the right to file such applications and the right to priority rights derived from said United States application under the Patent Laws of the United Convention for the Protection of Industrial Property, or any other international agreement or the patent in which any such application is filed, as may be applicable; and all forms of industrial unding, without limitation, patents, utility models, inventor's certificates and designs which may be an in any country or countries foreign to the United States and all extensions, renewals and
Official of any country of forms of industrial proper	horizes and requests the Commissioner of Patents and Trademarks of the United States, and any or countries foreign to the United States, whose duty it is to issue patents or other evidence or erty protection on applications as aforesaid, to issue the same to the said ASSIGNEE, its intatives and assigns, in accordance with the terms of this instrument; and
	venants and agrees that he has full right to convey the entire interest herein assigned, and has not secute, any agreement in conflict herewith; and
representatives and assig papers, execute all division everything possible to aid	ther covenants and agrees that he will communicate to the said ASSIGNEE, its successors, legal gas, any facts known respecting said invention, and testify in any legal proceeding, sign all lawful onal, continuing, reissue and foreign applications, make all rightful oaths, and generally do d the said ASSIGNEE, its successors, legal representatives and assigns, to obtain and enforce d invention in all countries.
Full name of sole or first Inventor's Signature	
Residence Tokyo, J	and the second s
	c/o NEC Corporation, 7-1, Shiba 5-chome, Minato-ku, Tokyo, Japan

11107805.01

Full name of second joint inventor, if any Taro KANEKO Second Inventor's Signature Java Kaneka Date June 3, 2004 Residence Tokyo, Japan Citizenship Japanese			
Second Inventor's Signature Jana Kanakas	Date June 3,2004		
Residence Tokyo, Japan	Citizenship Japanese		
Post Office Address c/o NEC Corporation,	7-1, Shiba 5-chome, Minato-ku, Tokyo, Japan		
Full name of third joint inventor, if any Third Inventor's Signature	Date		
Pasidence	Date Citizenship		
	On London p		
Tost Office Address			
Full name of fourth joint inventor, if any			
Fourth Inventor's Signature	Date		
Residence	Citizenship		
Post Office Address			
Full name of fifth joint inventor, if any	Dota		
HIRD Inventor's Signature	Date		
	Citizenship		
Post Office Address			
Full name of sixth joint inventor, if any			
Sixth Inventor's Signature	Date		
Residence	Citizenship		
Full name of seventh joint inventor, if any			
Seventh Inventor's Signature	Date		
Pacidence	DateCitizenship		
Post Office Address			
USI Office Fluid USS			
Full name of eighth joint inventor, if any			
Eighth Inventor's Signature	Date		
	Citizenship		
ost Office Address			
ull name of ninth joint inventor, if any			
inth Inventor's Signature			
esidence	Citizenship		
ost Office Address	Ortizonomp		
	·		
Witness: Arihide Noda			
11000.	- //// MITTO		
107805.01			

RECORDED: 09/01/2004 REEL: 015063

PATENT REEL: 015063 FRAME: 0945

Docket No.:____